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High Voltage Surface Mount Input Rectifier Diode, 20 A

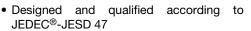


- 2			
D ² PAK	(TO-	263/	٩В

PRIMARY CHARACTERISTICS						
I _{F(AV)} 20 A						
V_{R}	800 V, 1200 V					
V _F at I _F	1.1 V					
I _{FSM}	300 A					
T _J max.	150 °C					
Package	D ² PAK (TO-263AB)					
Circuit configuration	Single					

FEATURES

- · Glass passivated pellet chip junction
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C



 Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



APPLICATIONS

- Input rectification
- Vishay Semiconductors switches and output rectifiers which are available in identical package outlines

DESCRIPTION

The VS-20ETS...S-M3 rectifier High Voltage Series has been optimized for very low forward voltage drop, with moderate leakage. The glass passivation technology used has reliable operation up to 150 °C junction temperature.

OUTPUT CURRENT IN TYPICAL APPLICATIONS							
APPLICATIONS SINGLE-PHASE BRIDGE THREE-PHASE BRIDGE UNITS							
Capacitive input filter T _A = 55 °C, T _J = 125 °C common heatsink of 1 °C/W	16.3	21	А				

MAJOR RATINGS AND CHARACTERISTICS								
SYMBOL CHARACTERISTICS VALUES UNIT								
I _{F(AV)}	Sinusoidal waveform	20	А					
V_{RRM}		800/1200	V					
I _{FSM}		300	А					
V _F	20 A, T _J = 25 °C	1.1	V					
T _J		-40 to +150	°C					

VOLTAGE RATINGS									
PART NUMBER	V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I _{RRM} AT 150 °C mA						
VS-20ETS08S-M3	800	900	1						
VS-20ETS12S-M3	1200	1300	1						

ABSOLUTE MAXIMUM RATINGS									
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS					
Maximum average forward current	I _{F(AV)}	T _C = 105 °C, 180° conduction half sine wave	20						
Maximum peak one cycle	l	10 ms sine pulse, rated V _{RRM} applied	250	А					
non-repetitive surge current	IFSM	10 ms sine pulse, no voltage reapplied	300						
Maximum I ² t for fusing	l ² t	10 ms sine pulse, rated V _{RRM} applied	316	- A ² s					
waximum i-t for fusing	1-1	10 ms sine pulse, no voltage reapplied	442						
Maximum I ² √t for fusing	l²√t	t = 0.1 ms to 10 ms, no voltage reapplied	4420	A²√s					

VS-20ETS08S-M3, VS-20ETS12S-M3 Series

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ELECTRICAL SPECIFICATIONS										
PARAMETER SYMBOL TEST CONDITIONS VALUES UN										
Maximum forward voltage drop	V_{FM}	20 A, T _J = 25 °C	1.1	V						
Forward slope resistance	r _t	T _{.1} = 150 °C	10.4	mΩ						
Threshold voltage	V _{F(TO)}	1j = 150 C	0.85	V						
Maximum reverse leakage current		T _J = 25 °C	$V_{B} = Rated V_{BBM}$	0.1	A					
waxiiiluiii ieveise leakage cuifelii	IRM	T _J = 150 °C	VR = nateu VRRM	1.0	- mA					

THERMAL - MECHANICAL SPECIFICATIONS									
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum junction and storage temper	erature range	T _J , T _{Stg}		-40 to +150	°C				
Maximum thermal resistance, junction to case		R _{thJC}	DC operation	1.3					
Maximum thermal resistance, junction to ambient		R _{thJA} (1)	For D ² PAK version	62	°C/W				
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth, and greased	0.5					
Approximate weight				2	g				
Approximate weight				0.07	OZ.				
minimum				6.0 (5.0)	kgf · cm				
Mounting torque	maximum			12 (10)	(lbf \cdot in)				
Marking device			Case style D ² PAK (TO-263AB)	20ETS08S					
			Case style D-FAR (10-203AB)	20ETS12S					

Note

⁽¹⁾ When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140 µm) copper 40 °C/W For recommended footprint and soldering techniques refer to application note #AN-994

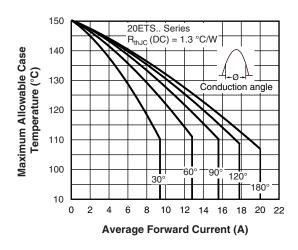


Fig. 1 - Current Rating Characteristics

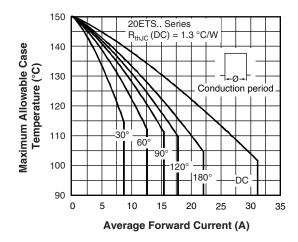


Fig. 2 - Current Rating Characteristics

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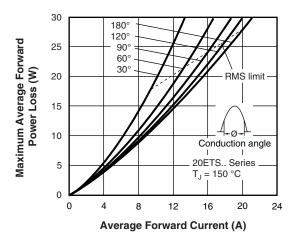


Fig. 3 - Forward Power Loss Characteristics

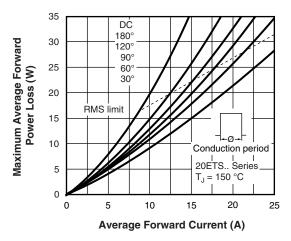


Fig. 4 - Forward Power Loss Characteristics

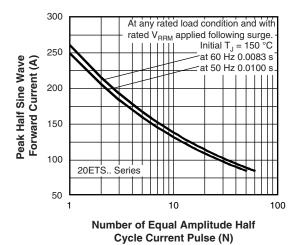


Fig. 5 - Maximum Non-Repetitive Surge Current

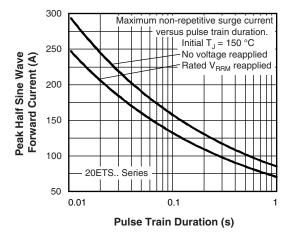


Fig. 6 - Maximum Non-Repetitive Surge Current

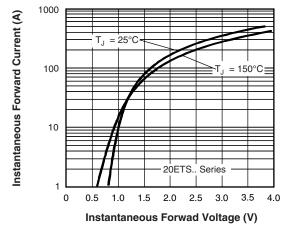


Fig. 7 - Forward Voltage Drop Characteristics

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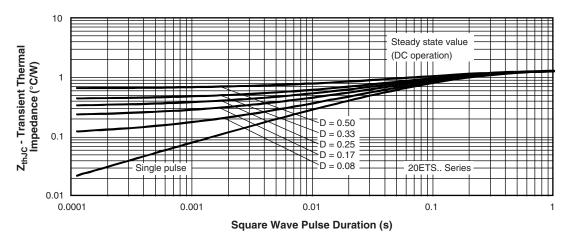
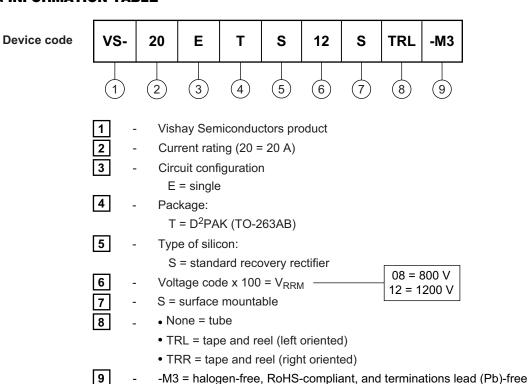


Fig. 8 - Thermal Impedance Z_{thJC} Characteristics

ORDERING INFORMATION TABLE





VS-20ETS08S-M3, VS-20ETS12S-M3 Series

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ORDERING INFORMATION (Example)								
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION						
VS-20ETS08S-M3	50	Antistatic plastic tube						
VS-20ETS08STRR-M3	800	13" diameter reel						
VS-20ETS08STRL-M3	800	13" diameter reel						
VS-20ETS12S-M3	50	Antistatic plastic tube						
VS-20ETS12STRR-M3	800	13" diameter reel						
VS-20ETS12STRL-M3	800	13" diameter reel						

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?96164			
Part marking information	www.vishay.com/doc?95444			
Packaging information	www.vishay.com/doc?96424			
SPICE model	www.vishay.com/doc?97266			



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D²PAK

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INC	HES	NOTES	NOTES	SYMBOL	MILLIM	ETERS	INC	HES	NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES	NOTES	STWBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			Е	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100	BSC	
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC	
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inches
- (7) Outline conforms to JEDEC® outline TO-263AB

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